



## 6-Pin DIP Random-Phase Optoisolators Triac Driver Output (400 Volts Peak)

The MOC3020 Series consists of gallium arsenide infrared emitting diodes, optically coupled to a silicon bilateral switch.

- **To order devices that are tested and marked per VDE 0884 requirements, the suffix "V" must be included at end of part number. VDE 0884 is a test option.** They are designed for applications requiring isolated triac triggering.

### Recommended for 115/240 Vac(rms) Applications:

- Solenoid/Valve Controls
- Lamp Ballasts
- Interfacing Microprocessors to 115 Vac Peripherals
- Motor Controls
- Static ac Power Switch
- Solid State Relays
- Incandescent Lamp Dimmers

### MAXIMUM RATINGS ( $T_A = 25^\circ\text{C}$ unless otherwise noted)

| Rating | Symbol | Value | Unit |
|--------|--------|-------|------|
|--------|--------|-------|------|

#### INFRARED EMITTING DIODE

|   |       |             |             |
|---|-------|-------------|-------------|
| Reverse Voltage   | $V_R$ | 3           | Volts       |
| Forward Current — Continuous  | $I_F$ | 60          | mA          |
| Total Power Dissipation @ $T_A = 25^\circ\text{C}$<br>Negligible Power in Triac Driver<br>Derate above $25^\circ\text{C}$ | $P_D$ | 100<br>1.33 | mW<br>mW/°C |

#### OUTPUT DRIVER

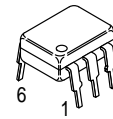
|   |           |          |             |
|---|-----------|----------|-------------|
| Off-State Output Terminal Voltage   | $V_{DRM}$ | 400      | Volts       |
| Peak Repetitive Surge Current<br>(PW = 1 ms, 120 pps)                                 | $I_{TSM}$ | 1        | A           |
| Total Power Dissipation @ $T_A = 25^\circ\text{C}$<br>Derate above $25^\circ\text{C}$ | $P_D$     | 300<br>4 | mW<br>mW/°C |

#### TOTAL DEVICE

|   |           |             |             |
|---|-----------|-------------|-------------|
| Isolation Surge Voltage <sup>(1)</sup><br>(Peak ac Voltage, 60 Hz, 1 Second Duration) | $V_{ISO}$ | 7500        | Vac(pk)     |
| Total Power Dissipation @ $T_A = 25^\circ\text{C}$<br>Derate above $25^\circ\text{C}$ | $P_D$     | 330<br>4.4  | mW<br>mW/°C |
| Junction Temperature Range  | $T_J$     | -40 to +100 | °C          |
| Ambient Operating Temperature Range   | $T_A$     | -40 to +85  | °C          |
| Storage Temperature Range   | $T_{stg}$ | -40 to +150 | °C          |
| Soldering Temperature (10 s)  | $T_L$     | 260         | °C          |

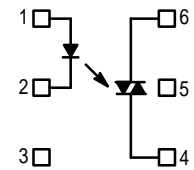
1. Isolation surge voltage,  $V_{ISO}$ , is an internal device dielectric breakdown rating. For this test, Pins 1 and 2 are common, and Pins 4, 5 and 6 are common.

**MOC3021**  
**MOC3022**  
**MOC3023**



STANDARD THRU HOLE

### SCHEMATIC



1. ANODE
2. CATHODE
3. NC
4. MAIN TERMINAL
5. SUBSTRATE  
DO NOT CONNECT
6. MAIN TERMINAL

**ELECTRICAL CHARACTERISTICS** ( $T_A = 25^\circ\text{C}$  unless otherwise noted)

| Characteristic | Symbol | Min | Typ | Max | Unit |
|----------------|--------|-----|-----|-----|------|
|----------------|--------|-----|-----|-----|------|

**INPUT LED**

|   |       |   |      |     |               |
|---|-------|---|------|-----|---------------|
| Reverse Leakage Current<br>( $V_R = 3\text{ V}$ ) | $I_R$ | — | 0.05 | 100 | $\mu\text{A}$ |
| Forward Voltage<br>( $I_F = 10\text{ mA}$ )       | $V_F$ | — | 1.15 | 1.5 | Volts         |

**OUTPUT DETECTOR** ( $I_F = 0$  unless otherwise noted)

|  |           |   |     |     |                  |
|--|-----------|---|-----|-----|------------------|
| Peak Blocking Current, Either Direction<br>(Rated $V_{DRM}^{(1)}$ )          | $I_{DRM}$ | — | 10  | 100 | nA               |
| Peak On-State Voltage, Either Direction<br>( $I_{TM} = 100\text{ mA Peak}$ ) | $V_{TM}$  | — | 1.8 | 3   | Volts            |
| Critical Rate of Rise of Off-State Voltage (Figure 7, Note 2)                | dv/dt     | — | 10  | —   | V/ $\mu\text{s}$ |

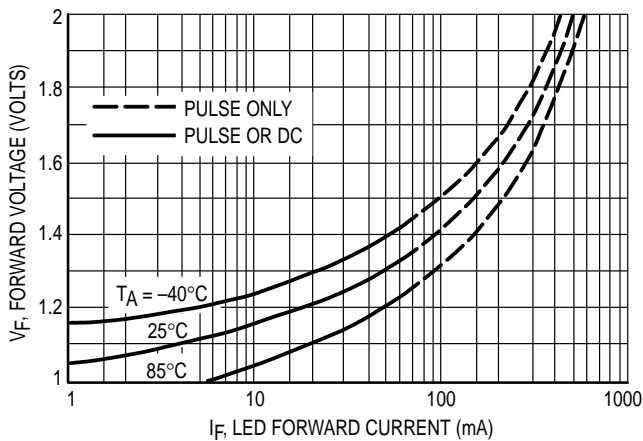
**COUPLED**

|  |          |   |     |   |               |
|--|----------|---|-----|---|---------------|
| LED Trigger Current, Current Required to Latch Output<br>(Main Terminal Voltage = 3 V <sup>(3)</sup> ) | $I_{FT}$ |   |     |   | mA            |
| MOC3021  | —        | 8 | 15  |   |               |
| MOC3022  | —        | — | 10  |   |               |
| MOC3023  | —        | — | 5   |   |               |
| Holding Current, Either Direction  | $I_H$    | — | 100 | — | $\mu\text{A}$ |

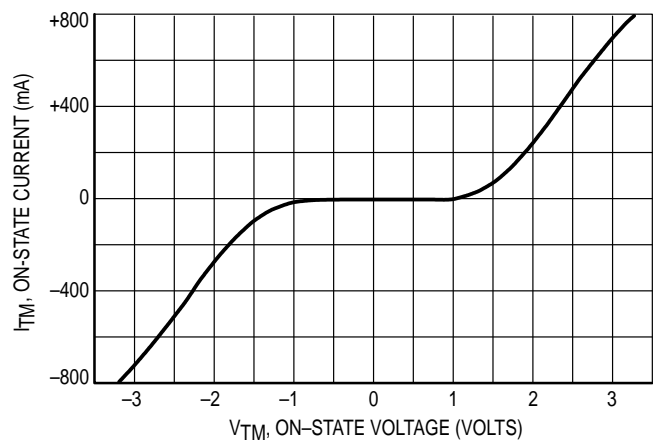
1. Test voltage must be applied within dv/dt rating.
2. This is static dv/dt. See Figure 7 for test circuit. Commutating dv/dt is a function of the load-driving thyristor(s) only.
3. All devices are guaranteed to trigger at an  $I_F$  value less than or equal to max  $I_{FT}$ . Therefore, recommended operating  $I_F$  lies between max  $I_{FT}$  (15 mA for MOC3021, 10 mA for MOC3022, 5 mA for MOC3023) and absolute max  $I_F$  (60 mA).

**TYPICAL ELECTRICAL CHARACTERISTICS**

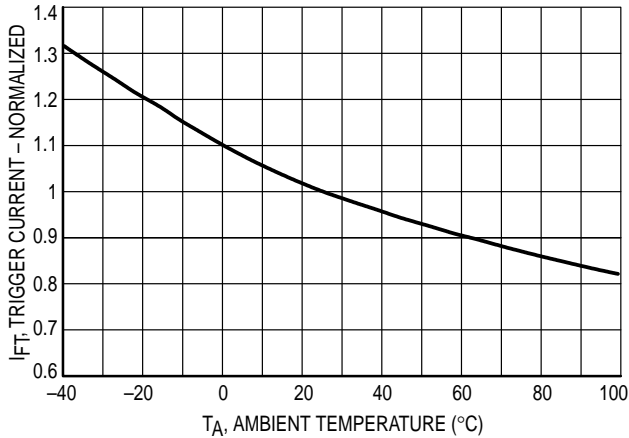
$T_A = 25^\circ\text{C}$



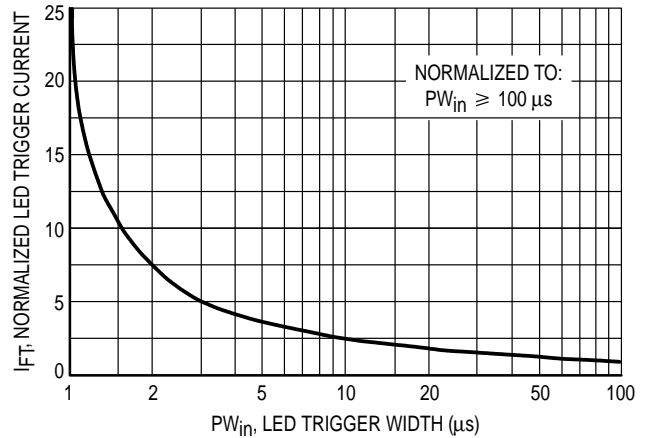
**Figure 1. LED Forward Voltage versus Forward Current**



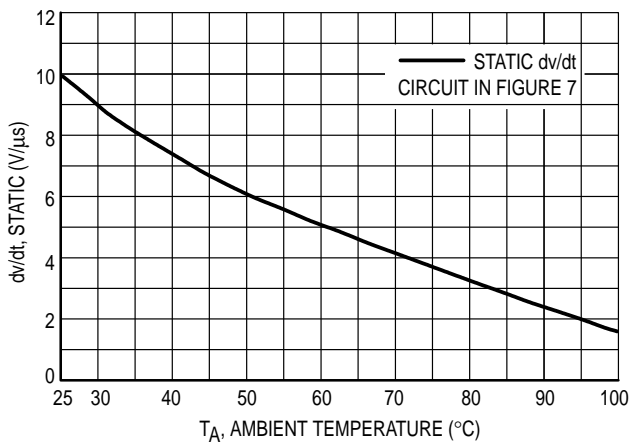
**Figure 2. On-State Characteristics**



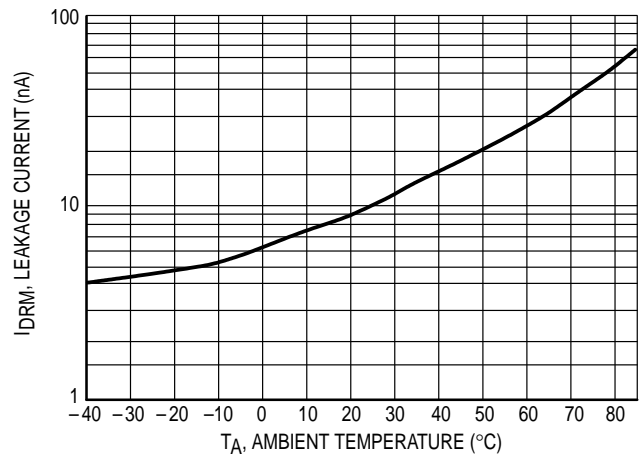
**Figure 3. Trigger Current versus Temperature**



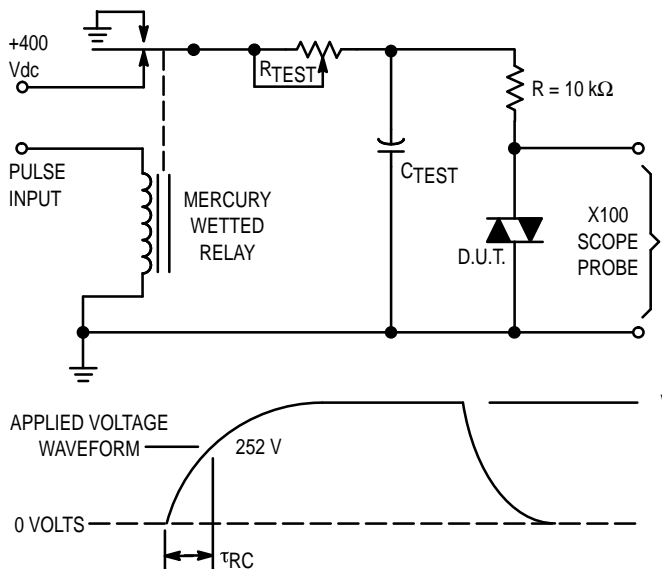
**Figure 4. LED Current Required to Trigger versus LED Pulse Width**



**Figure 5. dv/dt versus Temperature**

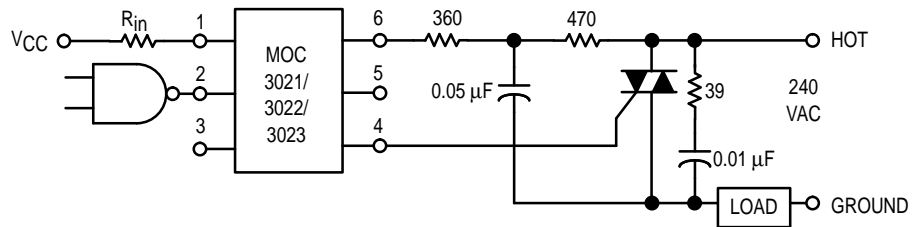


**Figure 6. Leakage Current, I<sub>DRM</sub> versus Temperature**



**Figure 7. Static dv/dt Test Circuit**

1. The mercury wetted relay provides a high speed repeated pulse to the D.U.T.
2. 100x scope probes are used, to allow high speeds and voltages.
3. The worst-case condition for static dv/dt is established by triggering the D.U.T. with a normal LED input current, then removing the current. The variable  $R_{TEST}$  allows the dv/dt to be gradually increased until the D.U.T. continues to trigger in response to the applied voltage pulse, even after the LED current has been removed. The dv/dt is then decreased until the D.U.T. stops triggering.  $\tau_{RC}$  is measured at this point and recorded.



\* This optoisolator should not be used to drive a load directly. It is intended to be a trigger device only.

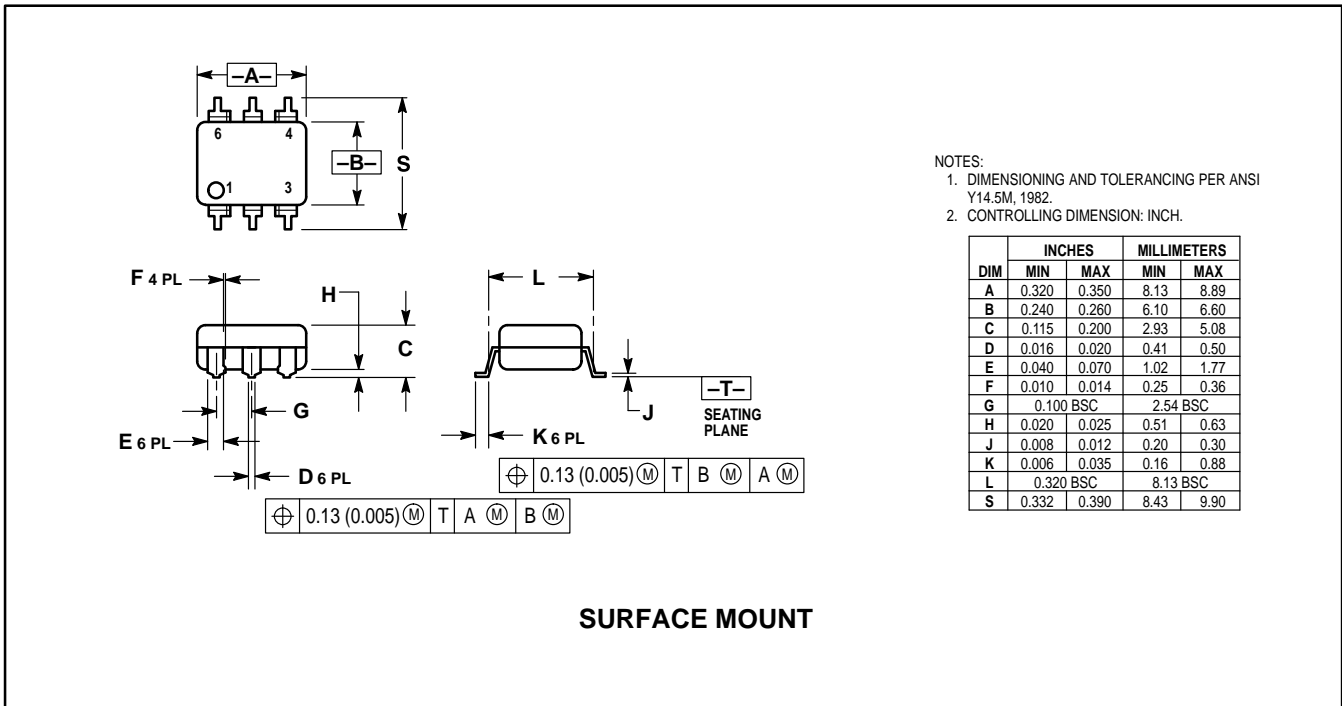
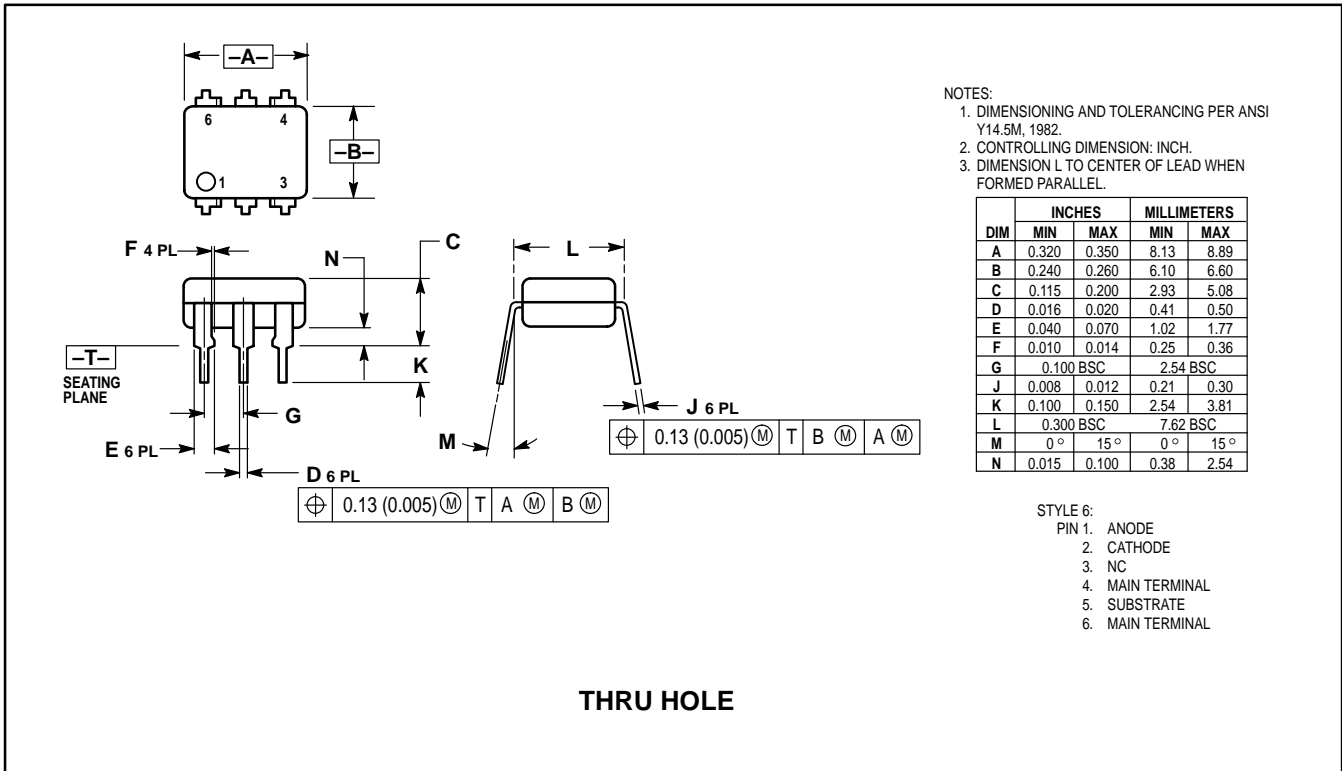
Additional information on the use of optically coupled triac drivers is available in Application Note AN-780A.

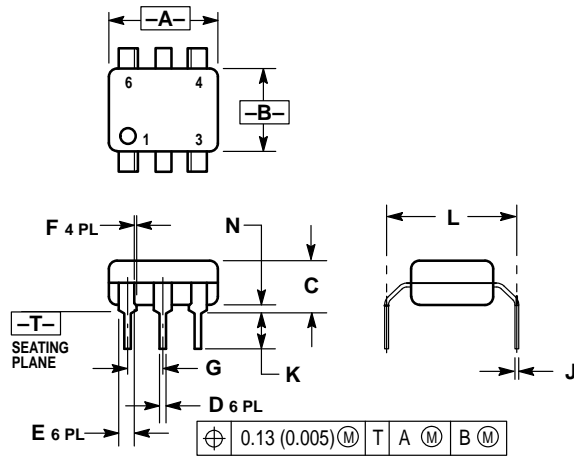
In this circuit the "hot" side of the line is switched and the load connected to the cold or ground side.

The 39 ohm resistor and 0.01  $\mu\text{F}$  capacitor are for snubbing of the triac, and the 470 ohm resistor and 0.05  $\mu\text{F}$  capacitor are for snubbing the coupler. These components may or may not be necessary depending upon the particular triac and load used.

**Figure 8. Typical Application Circuit**

**PACKAGE DIMENSIONS**





NOTES:

1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: INCH.
3. DIMENSION L TO CENTER OF LEAD WHEN FORMED PARALLEL.

| DIM | INCHES    |       | MILLIMETERS |       |
|-----|-----------|-------|-------------|-------|
|     | MIN       | MAX   | MIN         | MAX   |
| A   | 0.320     | 0.350 | 8.13        | 8.89  |
| B   | 0.240     | 0.260 | 6.10        | 6.60  |
| C   | 0.115     | 0.200 | 2.93        | 5.08  |
| D   | 0.016     | 0.020 | 0.41        | 0.50  |
| E   | 0.040     | 0.070 | 1.02        | 1.77  |
| F   | 0.010     | 0.014 | 0.25        | 0.36  |
| G   | 0.100 BSC |       | 2.54 BSC    |       |
| J   | 0.008     | 0.012 | 0.21        | 0.30  |
| K   | 0.100     | 0.150 | 2.54        | 3.81  |
| L   | 0.400     | 0.425 | 10.16       | 10.80 |
| N   | 0.015     | 0.040 | 0.38        | 1.02  |

**0.4" LEAD SPACING**

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